

PHAS0058

Physics of Advanced Materials

Lecture 4: Organic Field Effect Transistors (OFETs)

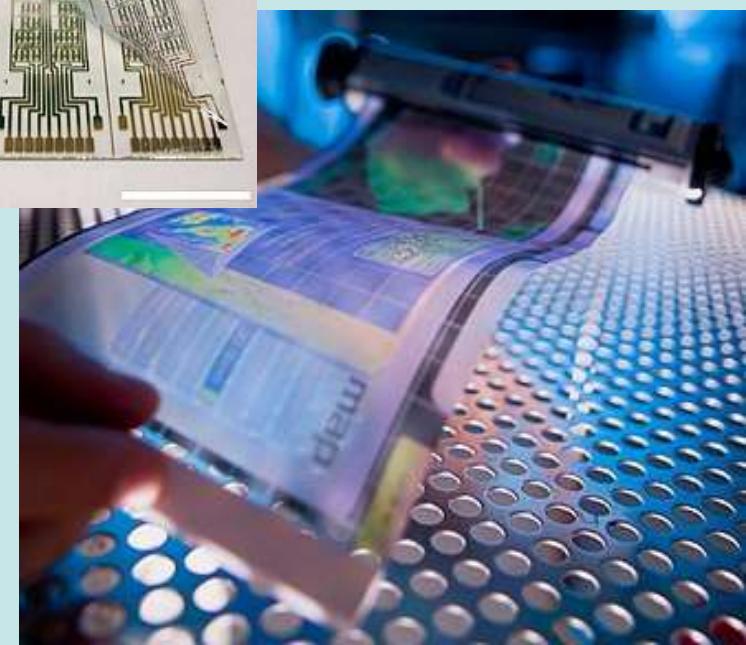
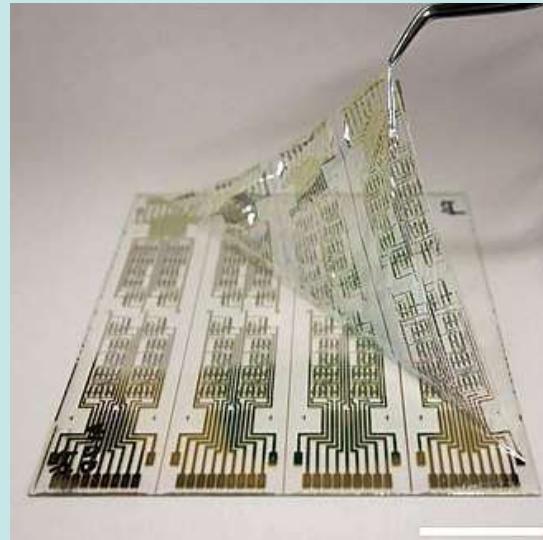
In this lecture...

- what are OFETs
- basic physics
- characterisation of OFETs
- materials
- optimisation
- Organic Thermoelectrics (OTEs)

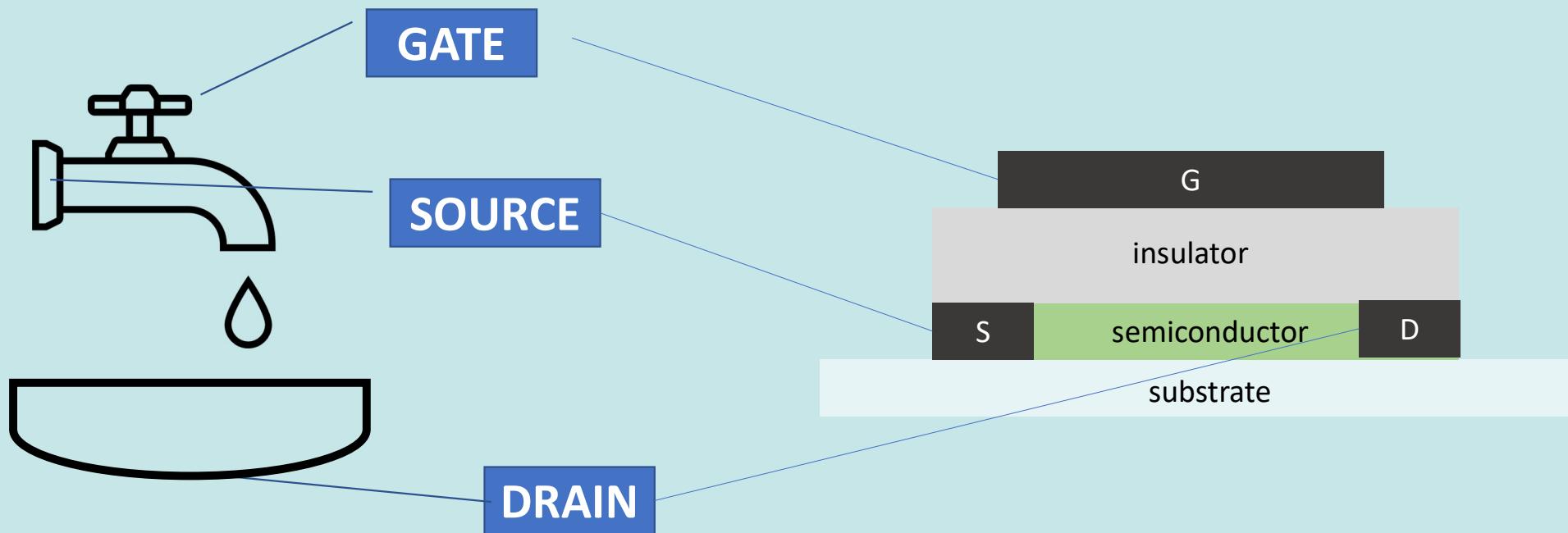
What are OFETs?

Motivation for OFETs

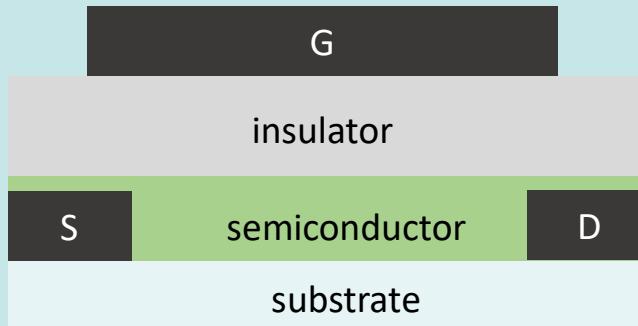
- **low performance logic**
 - **RFID tags**
 - **chip cards**
 - **e-paper**
- **high performance logic**
 - **driving stages for polymer displays**



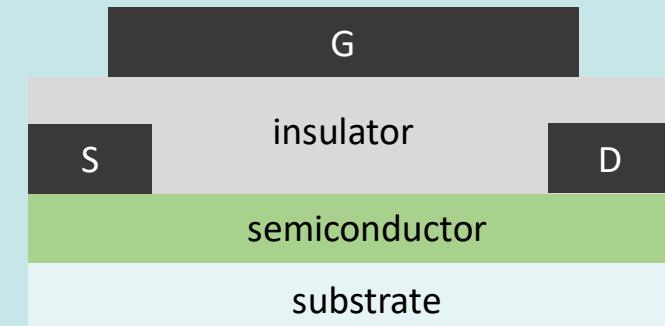
Field Effect Transistor



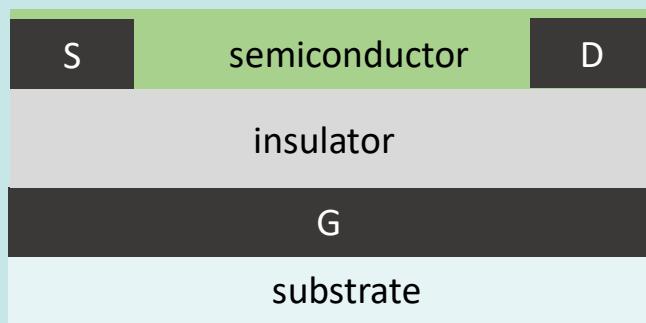
OFET architectures (OTFTs)



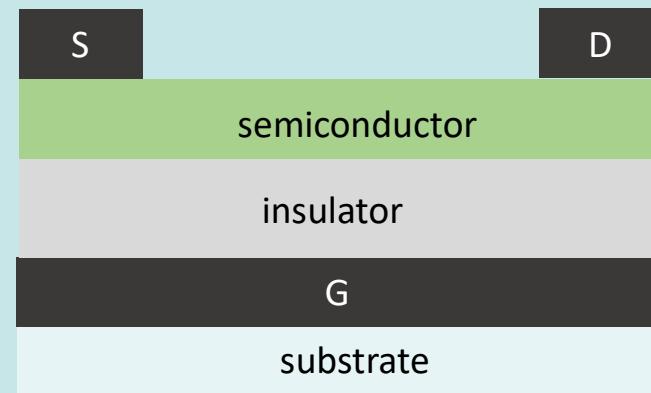
top gate, bottom contact



top gate, top contact

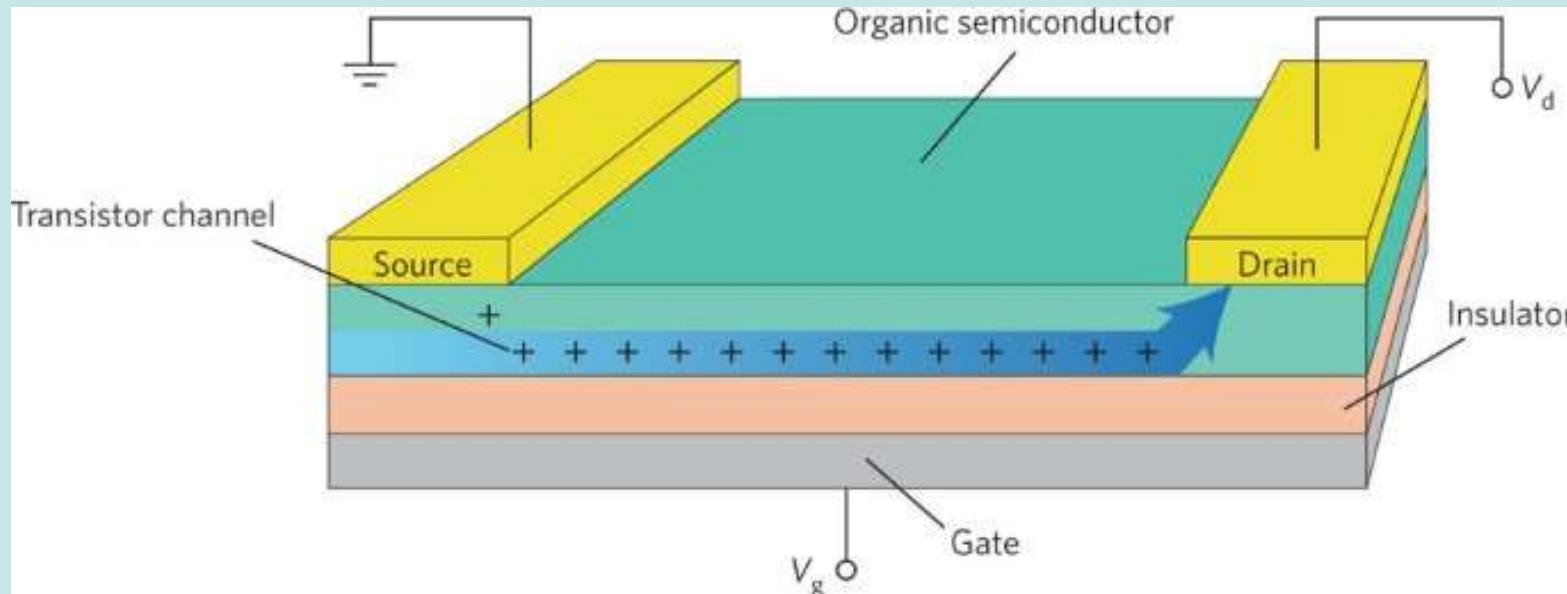


bottom gate, bottom contact



bottom gate, top contact

Transistor channel



- gate voltage causes charge accumulation in semiconductor by polarisation of the dielectric
- charge density modulated by gate field (“field effect”)
- reverse polarity by reversing gate voltage
- p-type, n-type or ambipolar – depending on the semiconductor

Characterisation of OFETs

Gradual channel approximation

assumptions:

- $\frac{L}{d} \geq 10$
- $V_G \gg V_{SD}$
- μ independent of applied E field

$$Q = -C_{diel}V_{total}(x)$$

$$V_{total} = V_G - V(x)$$

add threshold voltage to fill charge traps:

$$Q_{mobile} = -C_{diel}(V_{GS} - V(x) - V_{Th})$$

L – channel length

d – thickness of the dielectric

Q – density of charge in the channel

C_{diel} – dielectric capacitance per unit area

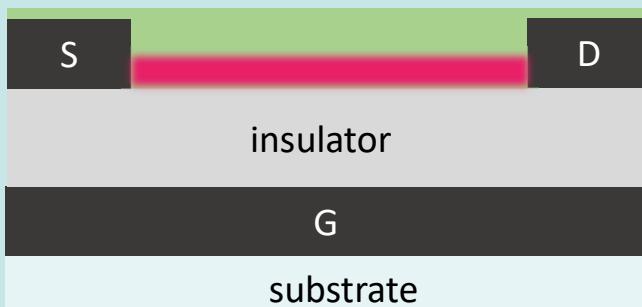
x – distance between S and D

V_{Th} – minimal voltage required for opening a channel

μ – charge mobility

Current in an OFET

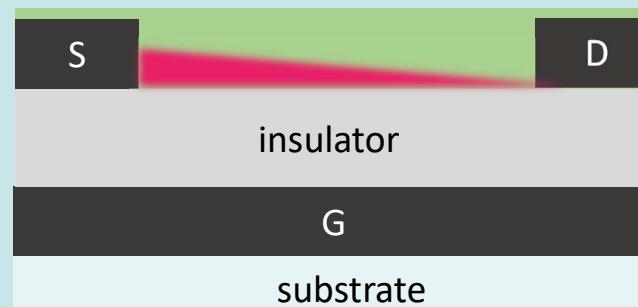
$$V_{DS} < |V_G - V_{Th}|$$



LINEAR REGIME

- free carriers available everywhere in the channel
- I_D increases with V_{DS}

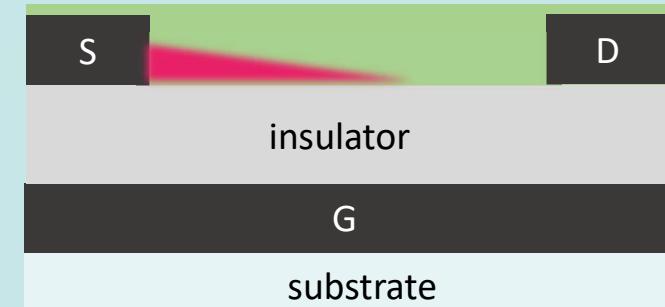
$$V_{DS} = |V_G - V_{Th}|$$



PINCH-OFF

- depletion of free carriers at D
- I_D starts to saturate

$$V_{DS} > |V_G - V_{Th}|$$



SATURATION REGIME

- depletion region grows
- I_D saturated (constant)

$$I_D = \mu W Q E_x = -\mu Q W \frac{dV}{dx}$$

$$I_D dx = \mu W C_{diel} (V_G - V(x) - V_{Th}) dV$$

W-channel width
Ex – electric field in the direction of current flow
 μ – charge-carrier mobility

Characterisation equations for OFETs

$$I_D = \frac{W}{L} \mu C_{diel} \left[(V_G - V_{Th})V_{DS} - \frac{1}{2} V_{DS}^2 \right]$$

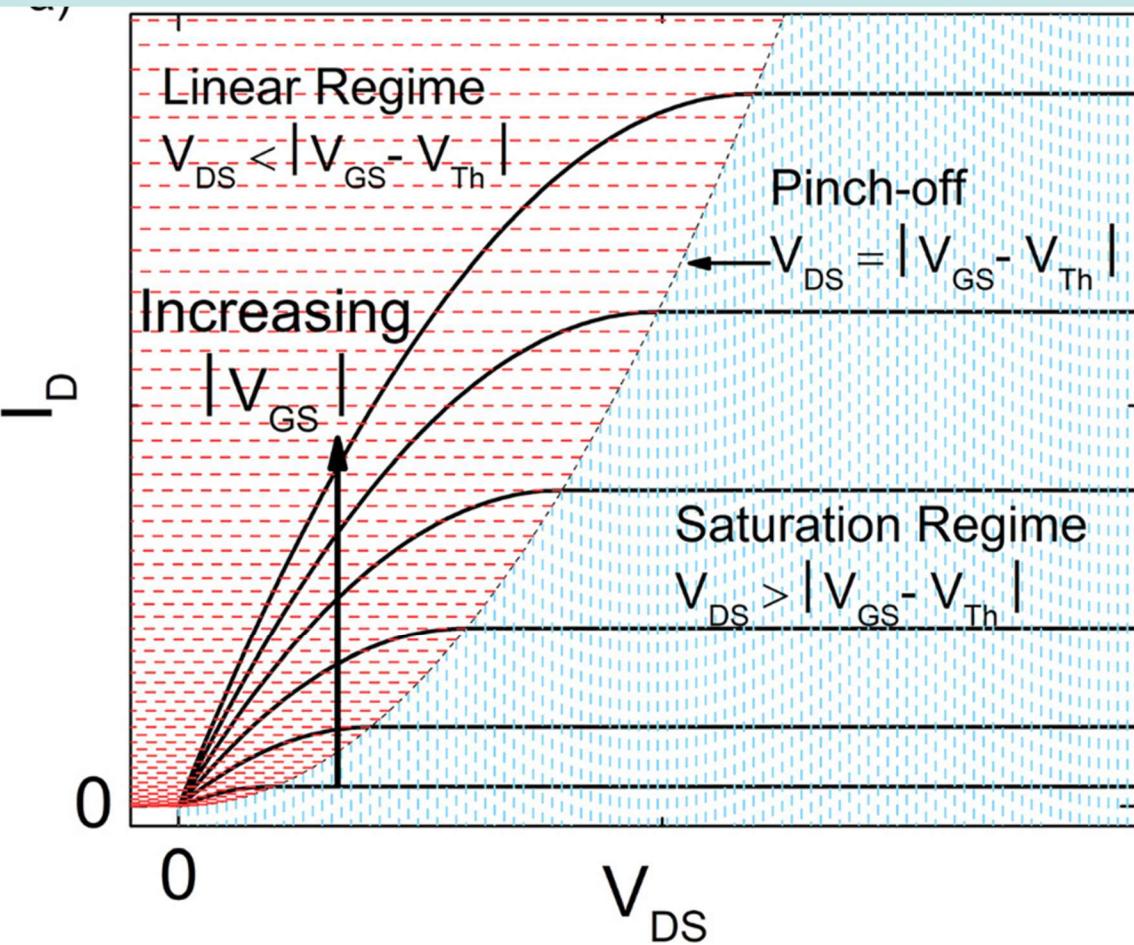
linear regime

once channel depletion starts, $V_{DS}=V_G-V_{Th}$ is the max effective voltage, so by substituting we get:

$$I_{D,sat} = \frac{W}{2L} \mu C_{diel} (V_G - V_{Th})^2$$

saturation regime

Output curves

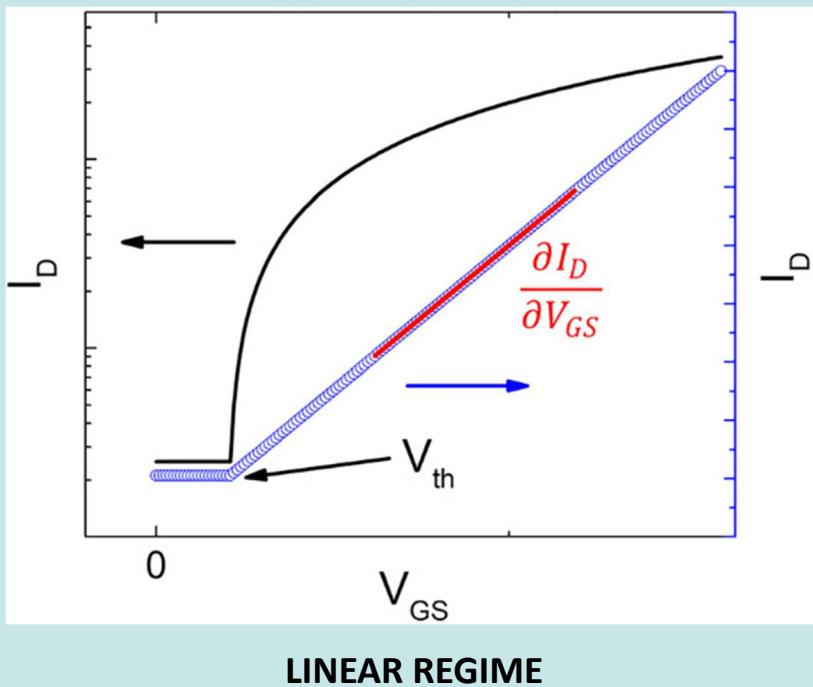


$$I_{D,lin} = \frac{W}{L} \mu C_{diel} \left[(V_G - V_{Th})V_{DS} - \frac{1}{2} V_{DS}^2 \right]$$

$$I_{D,sat} = \frac{W}{2L} \mu C_{diel} (V_G - V_{Th})^2$$

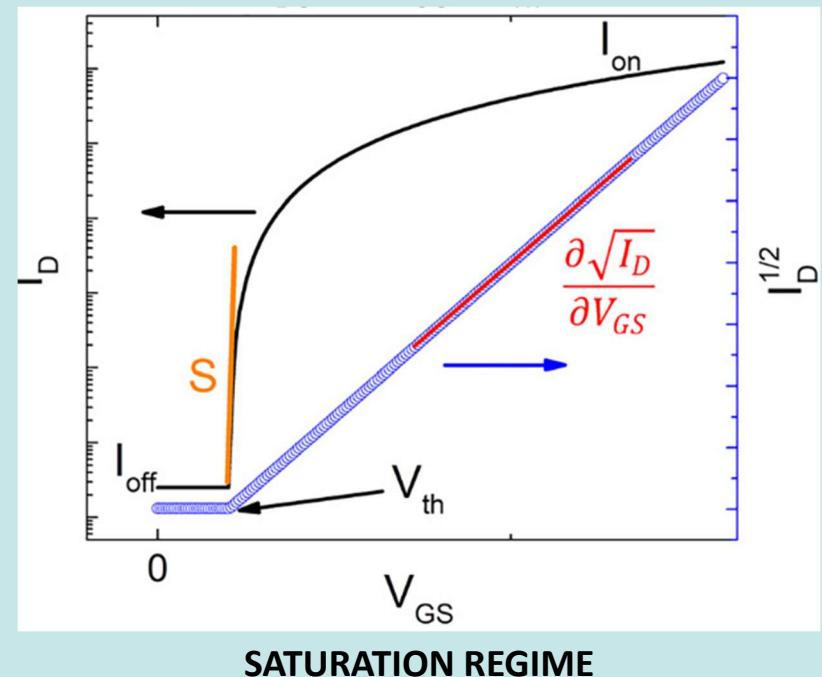
Transfer curves

$$V_{DS} < |V_G - V_{Th}|$$



$$I_{D,lin} = \frac{W}{L} \mu C_{diel} \left[(V_G - V_{Th})V_{DS} - \frac{1}{2}V_{DS}^2 \right]$$

$$V_{DS} > |V_G - V_{Th}|$$



$$I_{D,sat} = \frac{W}{2L} \mu C_{diel} (V_G - V_{Th})^2$$

Image from: Phys JA, Jurchescu OD (2019). J Appl Phys 124:071101

Extracting charge mobility

LINEAR REGIME

$$I_{D,lin} = \frac{W}{L} \mu C_{diel} \left[(V_G - V_{Th}) V_{DS} - \frac{1}{2} V_{DS}^2 \right]$$



$$\mu_{lin} = \frac{L}{C_{diel} W V_{DS}} \frac{\partial I_D}{\partial V_G}$$

SATURATION REGIME

$$I_{D,sat} = \frac{W}{L} \mu C_{diel} (V_G - V_{Th})^2$$



$$\mu_{sat} = \frac{2L}{WC_{diel}} \left(\frac{\partial \sqrt{I_D}}{\partial V_G} \right)$$

in theory: $\mu_{lin} = \mu_{sat}$
 in practice: $\mu_{lin} < \mu_{sat}$

Other characteristics of OFETs

- **density of interfacial traps**

- from threshold voltage change with temperature:

$$N_{it} = \frac{C_{diel}}{k_B T} \frac{\partial V_{Th}}{\partial T}$$

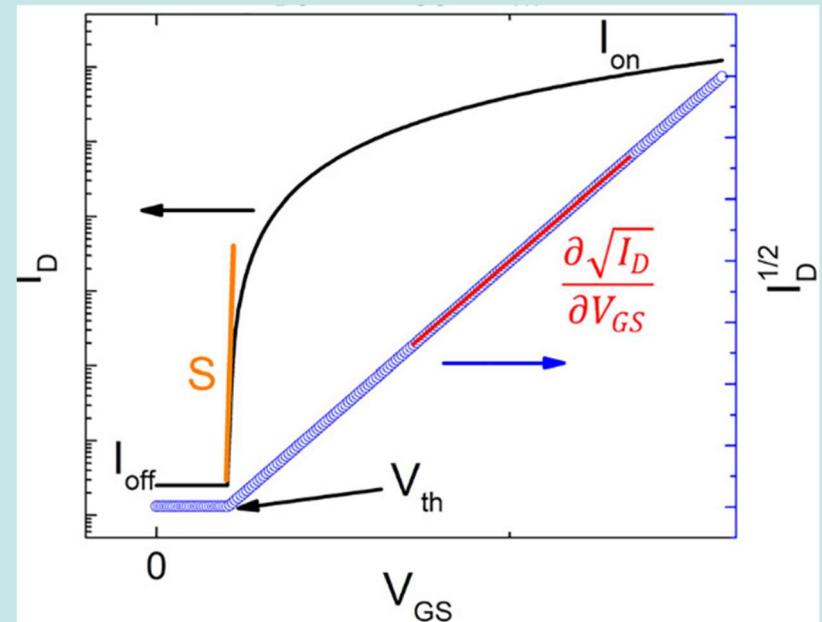
- from **subthreshold swing** (orange line)

- proportional to density of traps
- high subthreshold slope (low swing) = fast switching
- ideal value: < 1 V/dec

$$S = \frac{\partial V_G}{\partial (\log_{10} I_D)}$$

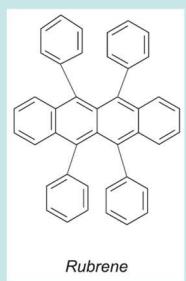
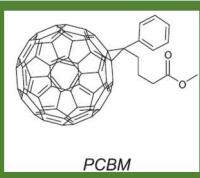
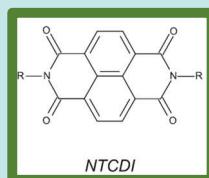
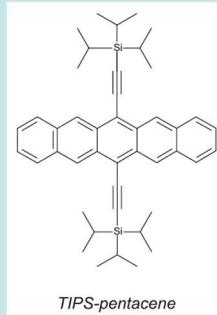
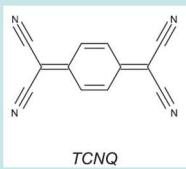
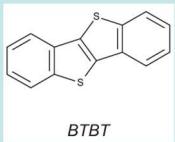
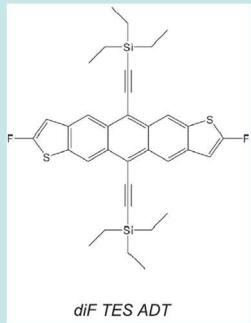
- **on/off ratio**

- defines switching capabilities
- I_{off} determined by dielectric material and semiconductor processing
- I_{on} determined by mobility, operating voltages, gate capacitance, trap density
- ideal value: 10^6

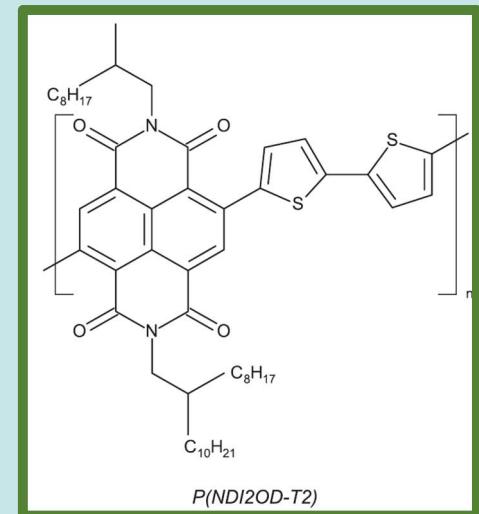
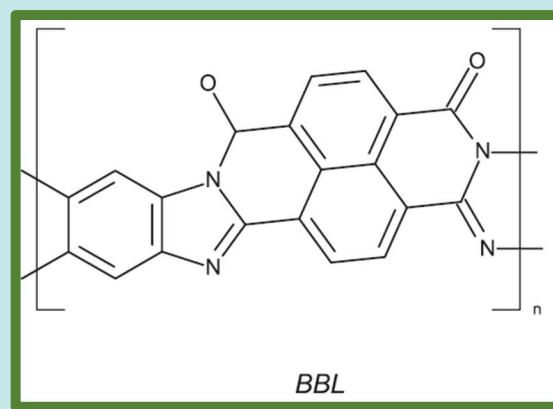
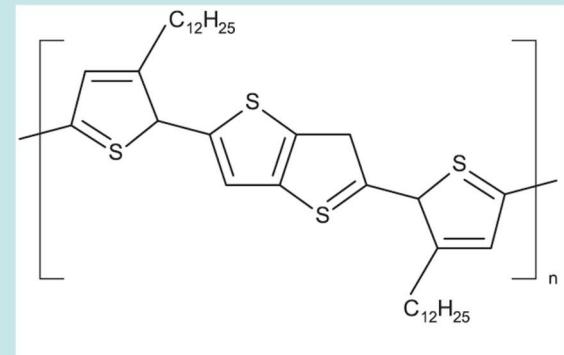
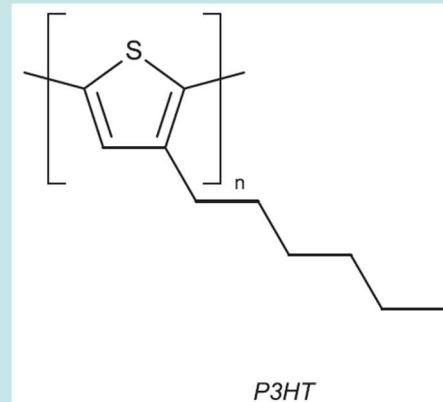


Organic materials for FETs

Materials for OFETs



small molecules



Rubrene single crystals

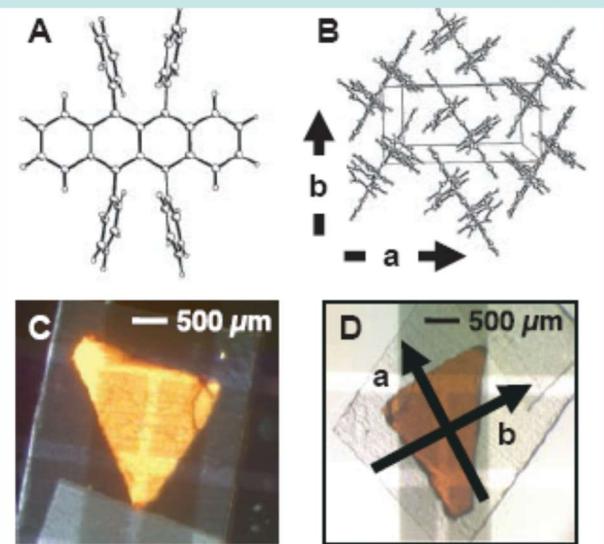
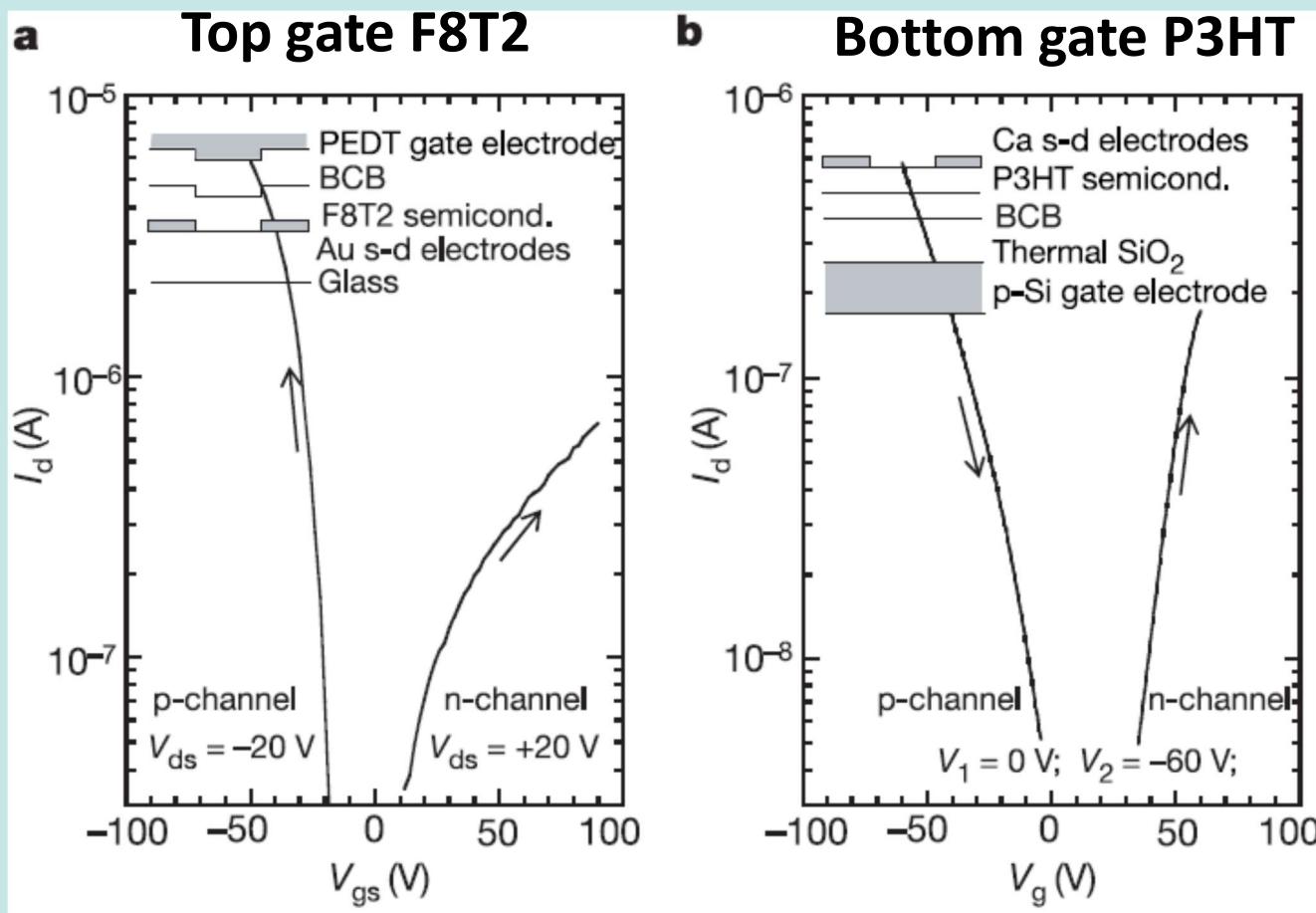


Fig. 2. (A) Molecular structure of rubrene. (B) Orthorhombic, crystallographic structure of a single crystal of rubrene shows the enhanced π - π overlap along the b direction and reduced overlap along the a direction. (C) Optical micrograph of a sample viewed through crossed polarizers. (D) Natural facets on the crystal surface correspond well to the crystallographic data and enable easy identification of the a and b axes confirmed by Laue diffraction.

- mobilities of $15 \text{ cm}^2/\text{Vs}$
- substituents allow favourable packing
- disadvantages:
 - rather fragile
 - requires PDMS stamping

Sundar et al. Science 303, 1644 (2004).

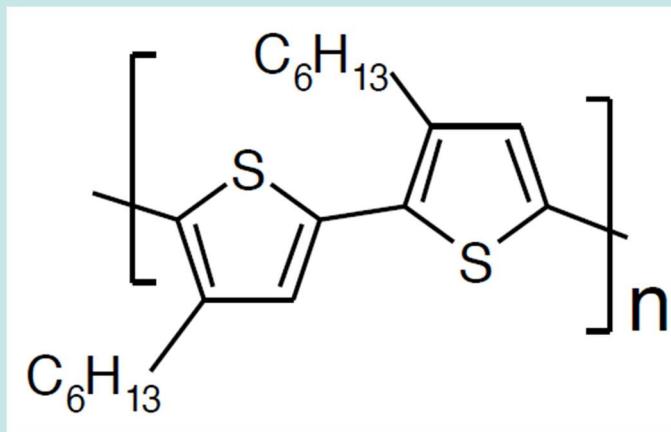
Ambipolar OFETs



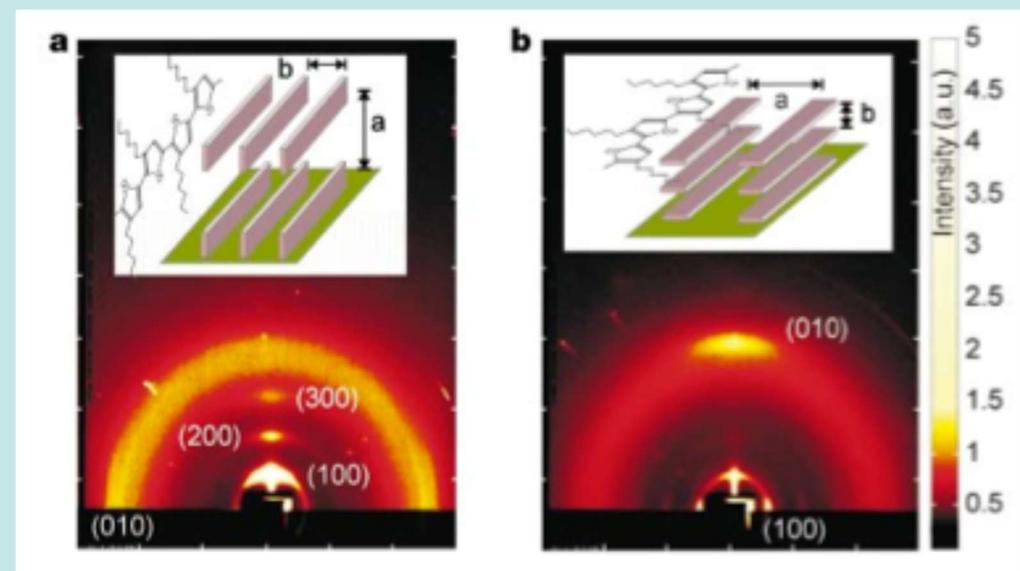
LL Chuah et al. Nature 434, 194 (2005)

P3HT

Regioregular Head-to-tail Poly(3-hexylthiophene),



mobilities of $0.1 \text{ cm}^2/\text{Vs}$
sufficient to drive an organic LED



Z. Bao, et al. Appl. Phys. Lett. 69, 4108 (1996)
H. Sirringhaus, et al. Science 280, 1741 (1998)

Optimisation of OFETs

Strategies for better performance

1) material design

- a) side chain engineering:
 - i. solubility
 - ii. molecular packing
 - iii. polarity
 - iv. film forming properties
- b) HOMO/LUMO design
- c) electrode materials
- d) improved conjugation
(polymers)

2) interface engineering

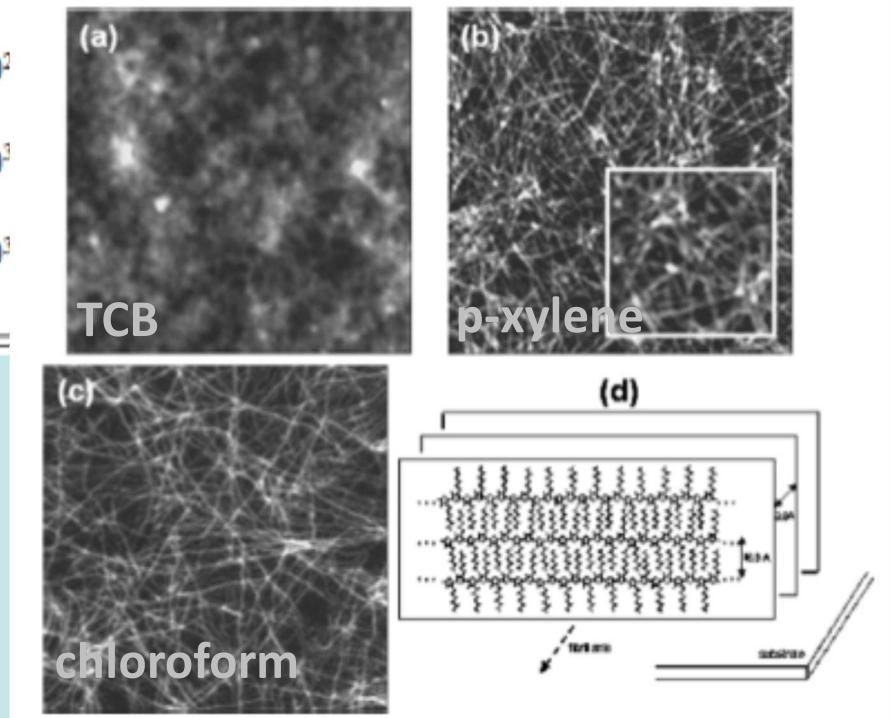
- a) charge injection layers

3) fabrication

- 1) deposition from solution:
 - a) spin-coating
 - b) drop-casting
 - c) printing
- 2) alignment
 - a) friction transfer
 - b) nanoimprinting
 - c) E/B field alignment
 - d) rubbing
 - e) dip-coating, zone-casting
 - f) ...

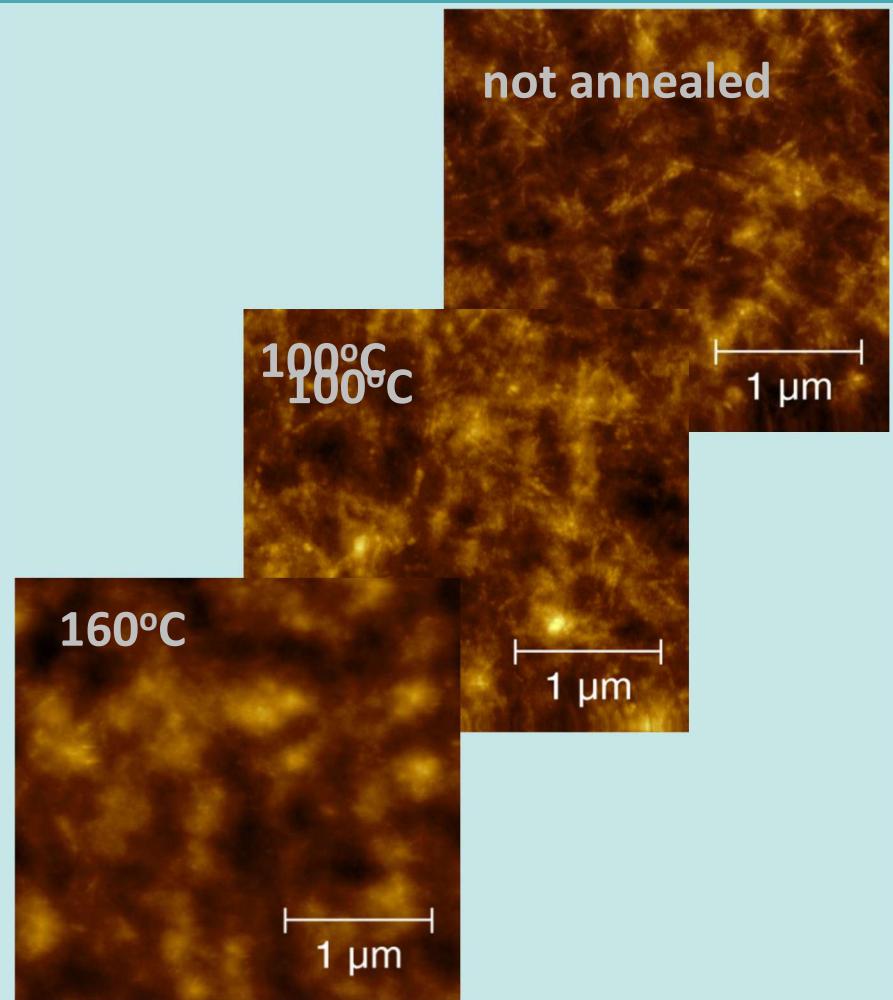
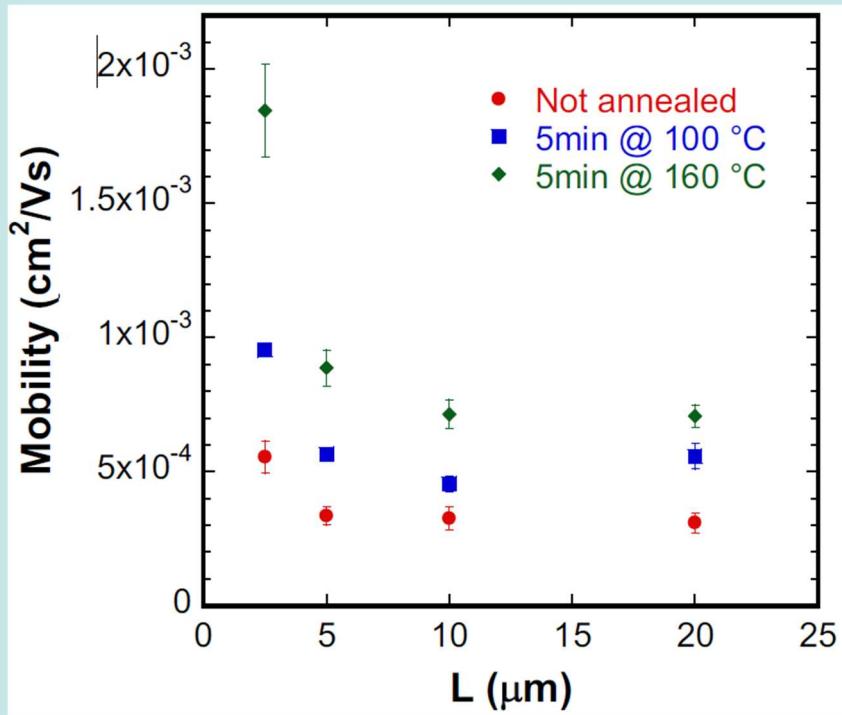
Fabrication parameters

Solvent/Process	Dip coating		Drop casting		Spin coating	
	μ	$I_{\text{on/off}}$	μ	$I_{\text{on/off}}$	μ	$I_{\text{on/off}}$
TCB (b.p. 213 °C)	2.4×10^{-3} ($\pm 0.7 \times 10^{-3}$)	$\sim 10^6$	1.5×10^{-4} ($\pm 1 \times 10^{-4}$)	$\sim 10^3$	2.3×10^{-2}	$\sim 4 \times 10^3$
p-xylene (b.p. 138 °C)	1.5×10^{-2} ($\pm 0.4 \times 10^{-2}$)	$\sim 10^4$	1.4×10^{-3} ($\pm 0.5 \times 10^{-3}$)	$\sim 10^2$		
Chloroform (b.p. 61 °C)	8.5×10^{-2} ($\pm 2 \times 10^{-2}$)	$\sim 5 \times 10^4$	2.1×10^{-2} ($\pm 0.3 \times 10^{-2}$)	$\sim 10^3$		
Chloroform on HMDS-treated SiO ₂	1.5×10^{-1} ($\pm 0.2 \times 10^{-1}$)	$\sim 2 \times 10^5$	2.3×10^{-3} ($\pm 0.2 \times 10^{-3}$)	$\sim 10^1$		



Annealing

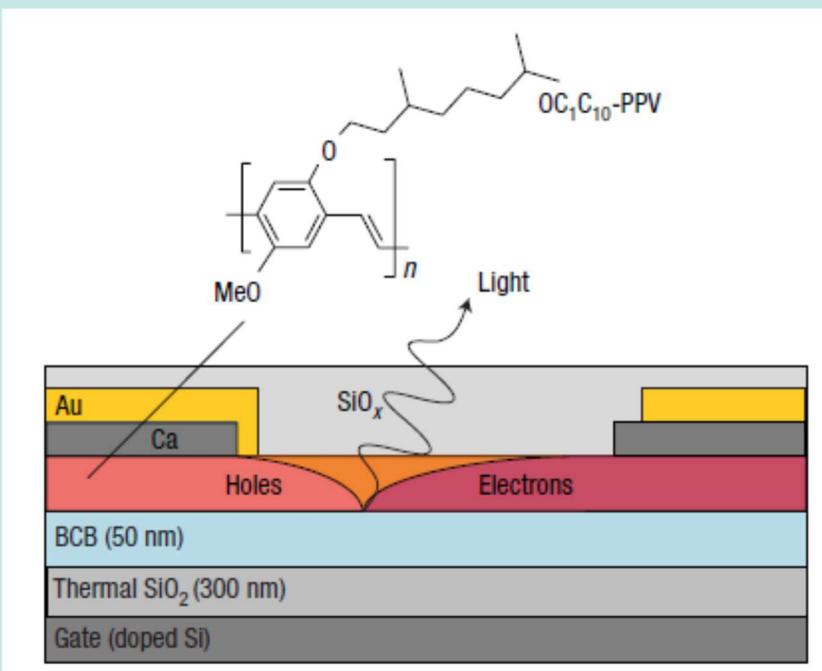
PPy3T



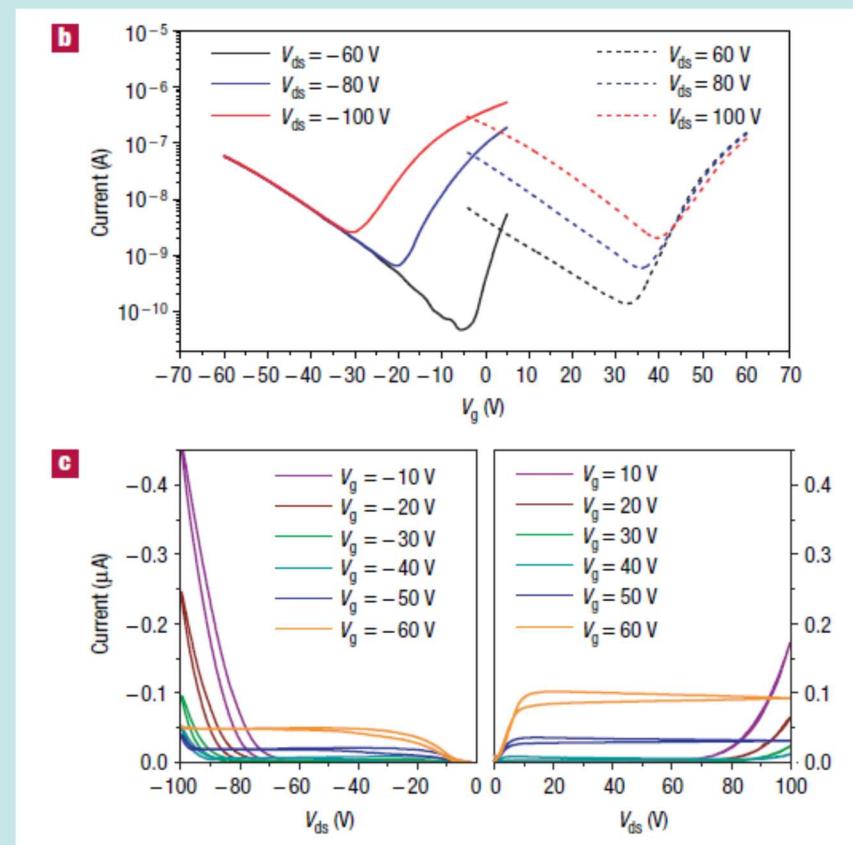
Li, Penglei et al. (2011) Chemical communications (Cambridge, England). 47. 8820-2. 10.1039/c1cc12752g.

OLETs

Organic Light Emitting Transistors

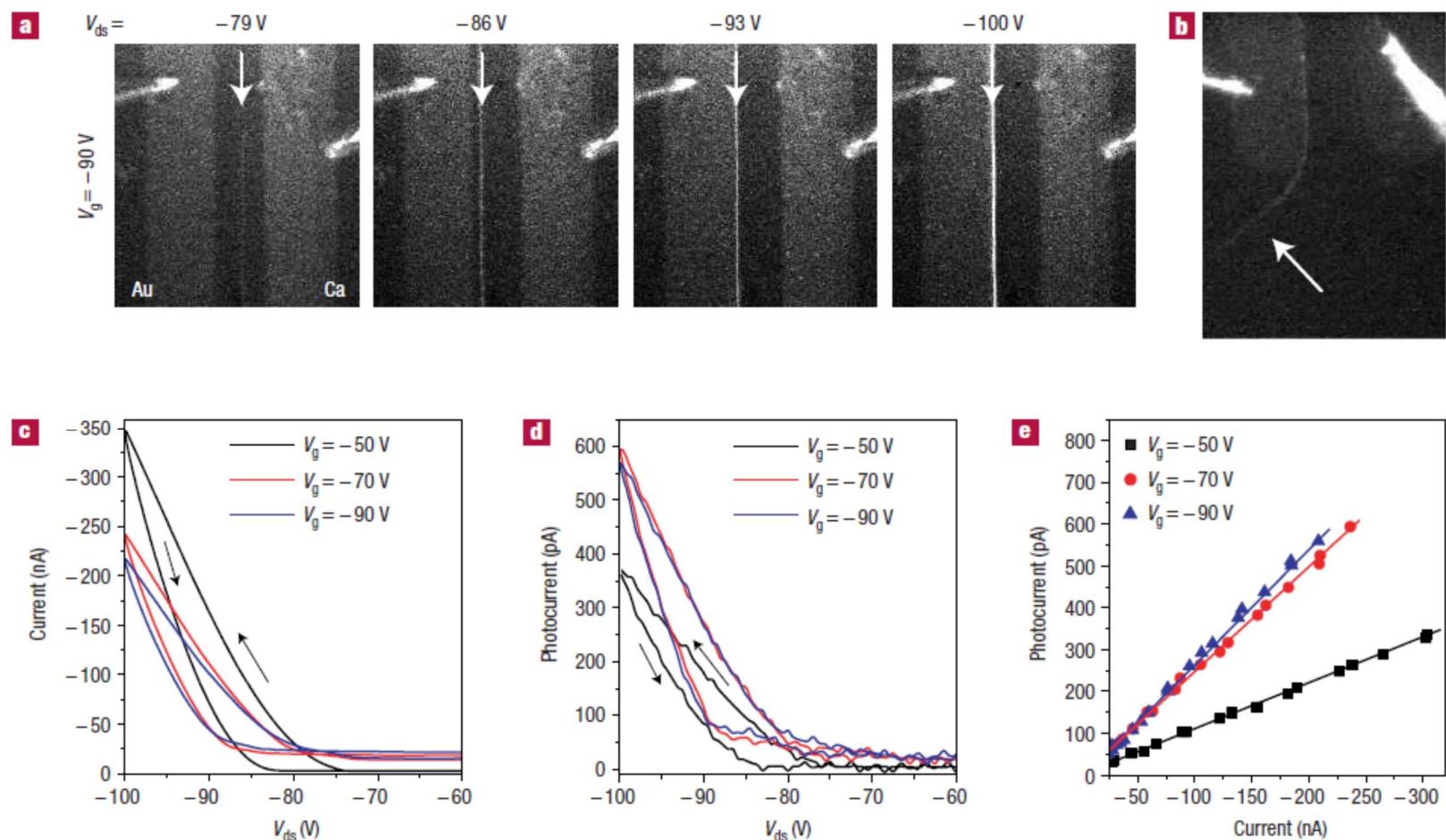


J Zaumseil et al, Nat. Mat. 5, 69 (2006)



OLETs

Organic



Summary

- Challenges:
 - stability of devices
 - active layer films with uniform morphology
 - fabrication methods suitable for large scale applications

Next week:

2D materials

Organic thermoelectrics

Motivation

70% of primary energy consumption wasted as heat

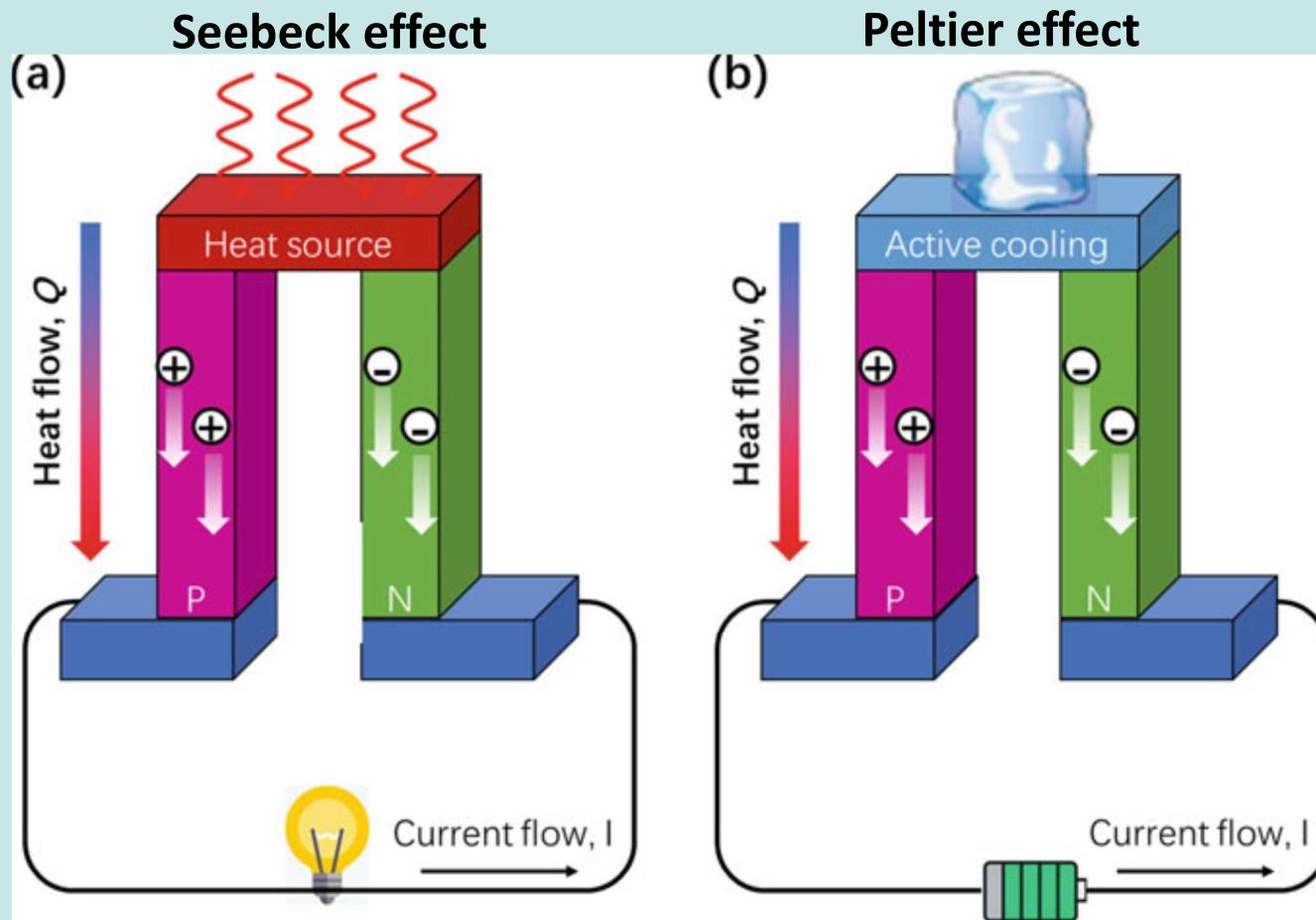
current inorganic materials:

- toxic
- not abundant
- costly processing (melt-spinning, hot pressing, ball milling)
- heavy and brittle

organic materials:

- none of the above
- additionally intrinsically low thermal conductivity

Seebeck and Peltier effect



Characterisation of thermoelectrics

Seebeck equation

$$S_{12} = \frac{V_1 - V_2}{T_1 - T_2}$$

- S - Seebeck coefficient (thermopower)
- T – temperature
- V – voltage
- Q – heat
- π - Peltier coefficient
- I - current from 1 to 2
- β – Thomson coefficient
- ZT – figure of merit
- σ – electrical conductivity
- κ – thermal conductivity
- PF – power factor

Peltier effect

$$Q = (\pi_1 - \pi_2)I$$

Thomson effect

$$Q = \beta I \Delta T$$

Figure of merit

$$ZT = \frac{S^2 \sigma T}{\kappa}$$

TEG efficiency

$$\eta = \frac{T_{hot} - T_{cold}}{T_{hot}} \frac{\sqrt{1 + ZT} - 1}{\sqrt{1 + ZT} + \frac{T_{cold}}{T_{hot}}}$$

$$PF = S^2 \sigma$$

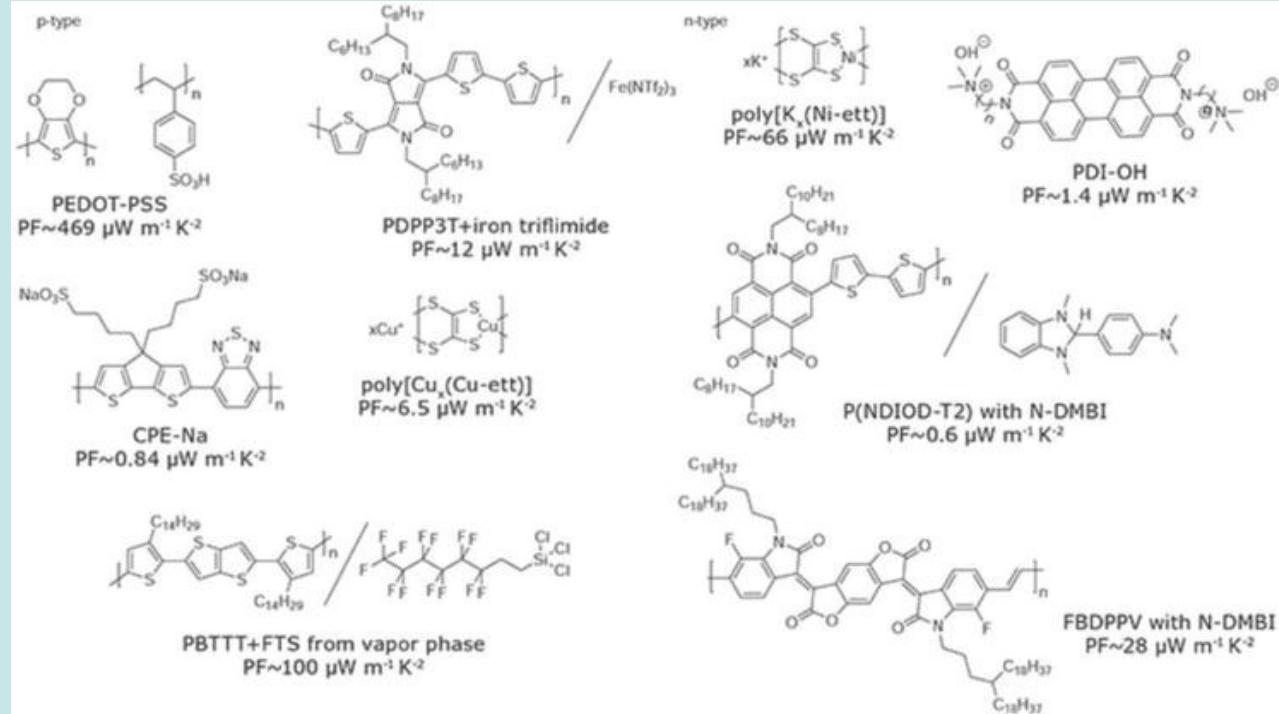
Organic thermoelectrics

Opportunities:

- anisotropic transport
- mW power extracted at 10K temperature difference
- flexibility
- body compatibility (non-toxic)

Challenges:

- low charge mobilities
- inferior Seebeck coefficients
- best materials usually organic-inorganic hybrids



Body heat application

